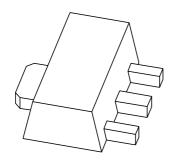
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS5250X 50 V, 2 A PNP low V_{CEsat} (BISS) transistor

Objective specification

2003 Jun 17





50 V, 2 A PNP low V_{CEsat} (BISS) transistor

PBSS5250X

FEATURES

- SOT89 (SC-62) package
- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability: I_C and I_{CM}
- Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements.

APPLICATIONS

- · Power management
 - DC/DC converters
 - Supply line switching
 - Battery charger
 - LCD backlighting.
- · Peripheral drivers
 - Driver in low supply voltage applications (e.g. lamps and LEDs).
 - Inductive load driver (e.g. relays, buzzers and motors).

DESCRIPTION

NPN low V_{CEsat} transistor in a SOT89 plastic package. NPN complement: PBSS4250X.

MARKING

TYPE NUMBER	MARKING CODE(1)			
PBSS5250X	*1L			

Note

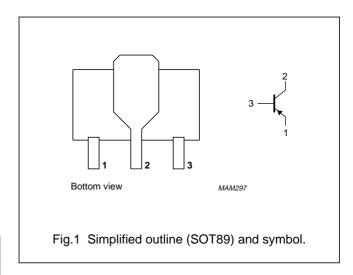
1. * = p : made in Hong Kong* = t : made in Malaysia* = W : made in China.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	-50	V
I _C	collector current (DC)	-2	Α
I _{CM}	peak collector current	- 5	Α
R _{CEsat}	equivalent on-resistance	160	mΩ

PINNING

PIN	DESCRIPTION		
1	emitter		
2	collector		
3	base		



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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-50	V
V _{CEO}	collector-emitter voltage	open base	_	-50	V
V _{EBO}	emitter-base voltage	open collector	_	- 5	V
I _C	continuous collector current (DC)		_	-2	Α
I _{CM}	peak collector current	T _{j max}	_	- 5	Α
I _B	continuous base current (DC)		_	-0.5	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
		note 1	_	550	mW
		note 2	_	1	W
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

Notes

- 1. Device mounted on a FR4 printed-circuit board; single-sided copper; tinplated; standard footprint.
- 2. Device mounted on a FR4 printed-circuit board; single-sided copper; tinplated; mounting pad for collector 1 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	in free air		
		note 1	225	K/W
		note 2	125	K/W
R _{th-js}	thermal resistance from junction to soldering point		16	K/W

Notes

- 1. Device mounted on a FR4 printed-circuit board; single-sided copper; tinplated; standard footprint.
- 2. Device mounted on a FR4 printed-circuit board; single-sided copper; tinplated; mounting pad for collector 1 cm².

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CHARACTERISTICS

 $T_j = 25$ °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{CBO}	collector cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0$	_	-100	nA
		$V_{CB} = -50 \text{ V}; I_E = 0; T_j = 150 ^{\circ}\text{C}$	_	-50	μΑ
I _{CES}	collector cut-off current	$V_{CE} = -50 \text{ V}; V_{BE} = 0$	_	-100	nA
I _{EBO}	emitter cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0$	_	-100	nA
h _{FE}	DC current gain	V _{CE} = −2 V			
		$I_{\rm C} = -0.1 {\rm A}$	200	_	
		$I_{C} = -0.5 \text{ A}$	200	_	
		$I_{C} = -1 \text{ A}$; note 1	200	_	
		$I_{C} = -2 \text{ A}$; note 1	100	_	
V _{CEsat}	collector-emitter saturation	$I_C = -0.5 \text{ A}; I_B = -50 \text{ mA}$	_	-90	mV
	voltage	$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	_	-250	mV
		$I_C = -2 \text{ A}; I_B = -100 \text{ mA}$	_	-380	mV
		$I_C = -2 \text{ A}; I_B = -200 \text{ mA}; \text{ note 1}$	_	-320	mV
R _{CEsat}	equivalent on-resistance	$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	_	160	mΩ
V _{BEsat}	base-emitter saturation voltage	ter saturation voltage $I_C = -2 \text{ A}$; $I_B = -100 \text{ mA}$		-1.1	V
V _{BEon}	base-emitter turn-on voltage	voltage $V_{CE} = -2 \text{ V}; I_C = -1 \text{ A}$		_	V
f _T	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	100	_	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	35	pF

Note

1. Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$

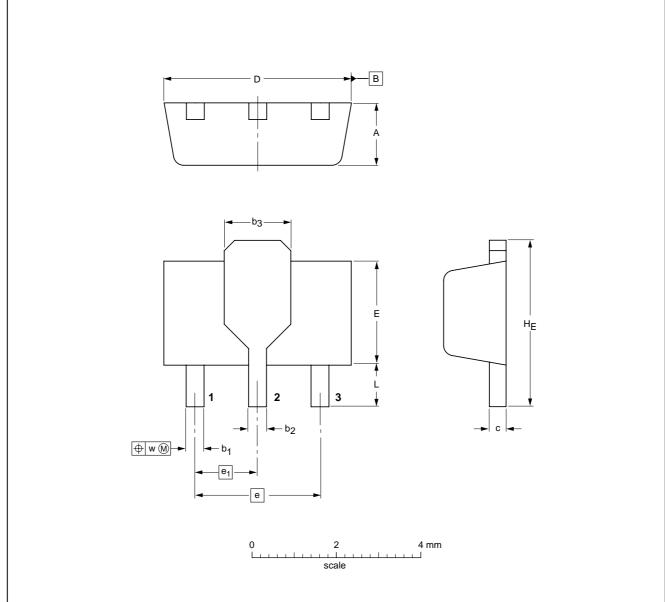
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PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 3 leads

SOT89



DIMENSIONS (mm are the original dimensions)

UNIT	A	b ₁	b ₂	b ₃	С	D	E	е	e ₁	HE	L min.	w
mm	1.6 1.4	0.48 0.35	0.53 0.40	1.8 1.4	0.44 0.37	4.6 4.4	2.6 2.4	3.0	1.5	4.25 3.75	0.8	0.13

OUTLINE	JTLINE REFERENCES					ISSUE DATE	
VERSION IEC		JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT89		TO-243	SC-62			97-02-28 99-09-13	

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DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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NOTES

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Printed in The Netherlands

613514/01/pp8

Date of release: 2003 Jun 17

Document order number: 9397 750 11624

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